

FPGA**Questions**

- LVDS ... don't we need to consider the common voltage so seriously?
 - ◆ Si5341 ... 1.8V
 - ◇ Common mode (CM) voltage (VDDO=1.8V) : 0.9V
 - Register of CM is 0x3E (0x0114 etc) but it could be 0x3D ? (see Table 11).
 - ◇ Swing : 430mV, it means the width of diff V is 860mV.
 - ◆ SY89833ALMG ... 1.2V
 - ◇ Common mode voltage : 1.2V
 - ◇ Swing : 325mV, it means the width of diff V is 650mV.
 - ◆ FPGA
 - ◇ GXB bank ... 1.03V for both SY89833ALMG and Si5341
 - ◇ GIO bank ... 1.5V for REFCLK_125M (SY89833ALMG), 1.8V for REFCLK_VAL_P0 (Si5341)

Tips

- In the DDR3 memory simulation, it is better to use ModelSim instead of Questa.
- Nios II Command Shell
 - ◆ We can find it in the Windows's menu (Go to the left-bottom of your Windows PC).
 - ◆ <https://service.macnica.co.jp/support/faq/127261> (instruction_master and data_master)
- SOPC Builder (System on a Programmable Chip Builder) --> Qsys --> Platform Designer
- PMA = Physical Media Attachment, PCS = Physical Coding Sublayer
 - ◆ PMD - PMA - PCS : Physical layer of OSI model
 - ◆ Our Gigabit Ethernet Transceiver (KSZ9031MNX) includes PMA and PCS, so that we need only MAC in FPGA.
 - ◇ MAC is in the Data Link layer of OSI model.
- FMax
 - ◆ http://www.altima.jp/column/fpga_edison/13i-Timing1.html
 - ◆ My image : Arria10 -> the max of FMax is around 1.5GHz.
- ADME = Altera Debug Master Endpoint
 - ◆ The ADME is a JTAG-based Avalon Memory-Mapped (Avalon-MM) master that provides access to the transceiver and PLL registers through the system console.
 - ◇ <https://www.intel.co.jp/content/www/jp/ja/programmable/documentation/joc1445446725697/>

Iroha

- 10AX115R3F40E2SG

Arria 10 GX FPGA Development Kit

- 6XX-44366R-0G
- 10APCIe0001623
- 10AX115S2F45I1SG
- 100-0321301-E3 REV E3.1
- Si5338 U26: I2C 7A, U14: I2C 7C, Si570 X3: I2C 00

MicroPOD

- Probably 14.0625 Gbps is supported.
- RX module ... base's color is black.
- TX module ... base's color is white.

SMA cable

- Huber+Suhner GX 03272
 - ◆ 50 Ohms, 3GHz
- Amphenol 135101-R1-M0.50
 - ◆ 50 Ohms, 12.4GHz

Tools

- FLUKE 66 IR Thermometer:
 - <https://www.fluke.com/en-us/product/temperature-measurement/ir-thermometers/fluke-66>
- FLUKE Ti95 IR Camera:
 - <https://www.fluke.com/ja-jp/product/thermal-imaging/thermography/fluke-ti95>

Iroha Pin

- Pull up pins at FPAG (Weak Pull-Up Resistor)
 - ◆ ADD_CH[0-3]
 - ◆ USER_DIP[0-3]
 - ◇ The side of the printed ON in the physical dip-switch of the IROHA is LOW.
 - ◆ nUSER_SW
 - ◇ Push ... LOW(=GND)
- Pin info
 - ◆ nP_RESET
 - ◇ Push ... LOW

DDR3 spec

- MICRON
- MT41J128M16HA-187E:D
- VDD=VDDQ=1.5V
- 128Megx16 = 2048Meg (128M16)
 - ◆ 128M address x 16 bits = 2048M bits = 256MByte, that is, MT41J128M16HA-187E:D is 256MByte DDR3 memory (I thought that it was 2GB but this is wrong).
- 96-ball
- Timing: 1.87ns@CL7 (DDR3-1066)
- Data Rate: 1066 MT/s
- Target tRCD-tRP-CL = 7-7-7
 - ◆ tRCD = 13.1ns
 - ◆ tRP = 13.1ns
 - ◆ CL(ns) 13.1ns
- DDR3-1066 = 1066MHz = 533MHz x 2(double), up to 8.533GB/s data transfer speed
- Configuration 16 Meg x 16 x 8 banks
 - ◆ Refresh count 8K
 - ◆ Row addressing 16K (A[13:0])
 - ◆ Bank addressing 8 (BA[2:0])

- ◆ Column addressing 1K (A[9:0])
- ◆ DQ pins (DQ[15:0])
- ◆ $2^{14} \times 2^{10} \times 8 \times 16 = 16 \times 1024 \times 1024 \times 8 \times 16$
- Mode : x8 mode
 - ◆ see <https://service.macnica.co.jp/support/faq/94701>, this is the case for Arria 10, I think.
 - ◇ I'm using two of x8 mode in the bank: DQ36 and DQ38.
- Pin location
 - ◆ We should run DDR3 example design to see if the pin assignment works well.
 - ◇ Read page 38 of "External Memory Interface Handbook Volume 2: Design Guidelines" (
https://www.altera.com/content/dam/altera-www/global/en_US/pdfs/literature/hb/external-memory-interface-handbook-volume-2-design-guidelines.pdf
)
 - Search for "*_altera_emif_arch_*_readme.txt", and then read Section 6 etc (Pin locations).

PHY (network)

- KSZ9031MNX
 - ◆ PHYAD[2:0] is set to be 000 in my design but it was 011. I don't understand this reason.
 - ◇ MDIO access can be done by 0x3 instead of 0x0.
 - ◆ MODE[3:0] is 0001.
 - ◆ LED MODE = 0
 - ◆ CLK125_EN = 0

Clock spec

- KC5032A100.000C1GE00
 - ◆ Jitter (peak-to-peak) = 40 ps

Comments for a next version of IROHA

- parts with a symbol of (and a symbol of) means they are not implemented.
- Polarity of micropod
- LED index should be the same order of dip switches etc on the board.
- More LED is better for debug, for example, 8 LEDs or more.
- Swap NIMOUT connections (in the 1st page) : this is my mistake.
- U40 (Current monitor) and U41 were removed (by Ikeno-san) due to a wrong design. We need to fix the design.
 - ◆ Wrong pins in U41
- U7 (Ethernet) : R33 and R34 was re-connected to 1.8V (by Ikeno-san).
 - ◆ According to Ikeno-san, this tip has a bug, where there is no plan to fix it by its provider.
- Reset switch is not stable.
 - ◆ We might use 1.8V instead of 3.3V for VDD and SENSE.

Test04 (under IrohaArria10/@HP Note PC)

- LED, Dip switch check
- Clocks
 - ◆ 100M clock (originally for DDR3) with DSP (IO PLL Intel FPGA IP) ... done
 - ◆ 125M diff-clock cannot be used yet.

Test06-DDR3 (under IrohaArria10/@HP Note PC)

- try to use DDR3 memory but I cannot get it...
- qsf (20180817v2) was made from 20180817 by replacing emif with DDR3 and also add 1.5V info to all the DDR3 pins. However this new file cannot be read properly. I did not understand its reason. * "Clean project" can help us! This can be found in "Project".

Test01 (under IrohaArria10/@Desktop PC)

- LED, Dip switch check
- It works well.

Test02 (under IrohaArria10/@Desktop PC)

- Nios II but it does not work.

Test03-DDR3 (under IrohaArria10/@Desktop PC)

- DDR3 memory but it does not work. -> It worked well (it means that the Fitter worked well. It does not mean that we can read/write data to/from DDR3 memory).
 - ◆ emif_0_example_design_v3/qii/ed_synth/
- Jan 2019: emif_0_example_design_v3/sim/ed_sim/mentor/
 - ◆ Simulation with ModelSim DE 10.6e worked well.
 - ◇ Procedure
 - Run ModelSim, Change directory (from "File" menu) to emif_0_example_design_v3/sim/ed_sim/mentor, do "source msim_setup.tcl" and "ld" (or "ld_debug"), then "run -all" in the Transcript window.
 - Some waves will be changed and we can see some messages in the Transcript window from around 95us. About 280us was simulated in case of "Skip calibration".

```
#          --- SIMULATION PASSED ---
# ** Note: $finish      : ../../altera_emif_sim_checker_180/sim/altera_emif_sim_checker.sv(230)
# Time: 279455890 ps  Iteration: 4  Instance: /ed_sim/sim_checker
```

- Jan 2019: emif_0_example_design_v3/qii/ed_synth
 - ◆ EMIF parameters
 - ◇ Used values from a DDR3 ref note (Micron) as much as possible.
 - ◇ 400MHz is used. PLL becomes 100MHz.
 - If I set it to 533MHz, PLL becomes 133.25MHz (=533/4).
 - Even if I used 533 and 133.25 in the setting but 100MHz as a real clock, I got 1010 (LEDs).
 - ◆ Compiled with ed_synth.qsf (see name and location of pins of DDR3 etc).
 - ◇ nUSER_SW (PIN_AU20) as global_reset_reset_n.
 - ◇ oct_oct_rzqin is connected to PIN_G16 (100 Ohm) but I don't if this is correct.
 - ◆ I saw the next result in IROHA's LED (1010):
 - ◇ emif_0_status_local_cal_success ... LED on
 - ◇ emif_0_status_local_cal_fail ... LED off
 - ◇ emif_0_tg_0_traffic_gen_pass ... LED on
 - ◇ emif_0_tg_0_traffic_gen_timeout ... LED off
 - <https://www.intel.com/content/www/us/en/programmable/support/support-resources/knowledge-base/solutions>
 - ◆ Termination logic option is set to Differential for input \, but setting is not supported by I/O standard <single-ended I/O standard>

- ◆ Change PHYS Clock in IP
- I used `ARRIA_10_RF40_4_20180825DDR3try1-removeunused-forAlteraExample-renamedToDDR3` but it did not work well.
- I tried to fit DDR3 several times by changing pin assignment. However this was not a failure reason. By removing one of "always", the fitter did work well. I don't know its reason.
- EMIF example
 - ◆ I made an example by using qsys.
 - ◆ I followed the next video:
 - ◇ <https://www.youtube.com/watch?v=QV77CrTBAAI>
 - ◇ <https://www.youtube.com/watch?v=chmiGrXUxVs>

Test04-DDR3 (under IrohaArria10/@Desktop PC)

- The purpose of this dir is the same as Test03-DDR3 but this has an example dir.
- DDR3 memory but it does not work.
- `emif_0_example_design_qii/ed_synth`
 - ◆ Can do "Fitter" etc w/o any error (using the default example code) ... setting A
 - ◆ Then, constraint pins with `ARRIA_10_RF40_4_20180825DDR3try1-reassign-removeunused-forAlteraExample` but pins assignment is the same as the "setting A". -> worked well.
 - ◆ Then, constraint pins as IROHA with `ARRIA_10_RF40_4_20180825DDR3try1-removeunused-forAlteraExample`. -> worked well.
 - ◇ In both, I removed `set_instance_assignment -name IO_STANDARD "1.5 V" -to emif_0_pll_ref_clk_clk`.
 - For `ARRIA_10_RF40_4_20180825DDR3try1-reassign-removeunused-forAlteraExample` I also removed the pin setting of `emif_0_pll_ref_clk_clk`.
 - For `ARRIA_10_RF40_4_20180825DDR3try1-removeunused-forAlteraExample`, I tried both (the pin setting of `emif_0_pll_ref_clk_clk` is set or not) and both of them worked well.

Test05-GXB (under IrohaArria10/@Desktop PC)

- References
 - ◆ <https://service.macnica.co.jp/support/faq/121865>
 - ◆ <https://service.macnica.co.jp/support/faq/121665>
- "Basic (Enhanced PCS)" might be needed for high speed link like 10Gbps but I cannot use it because P/N pins are inversed in some GXB pins.
 - ◆ When I designed PCB, I thought that we can swap polarity by using IP core etc but this is the case for "Basic (Standard PCS)", which is 4Gbps or slower. Anyway I use this mode at the moment.
 - ◆ I swaped P/N polarity by using `tx_polinv` and `rx_polinv` (12'b100110011001).
 - ◆ <https://www.intel.com/content/www/us/en/programmable/support/support-resources/knowledge-base/>

Test06-CLK (under IrohaArria10/@Desktop PC)

- converted LVDS clocks to the single-end signal clock (helps from Nicolas).
 - ◆ Use the next 2 lines
 - ◇ `set_instance_assignment -name IO_STANDARD LVDS -to REFCLK_125M_P`
 - ◇ `set_instance_assignment -name INPUT_TERMINATION DIFFERENTIAL -to REFCLK_125M_P`
- qsf file

- ◆ DON'T constraint _N pins in this file. This is very important! I need to fix my qsf.
- ◆ Also, it is better to constraint only PINs I use for each design (first).

Test07-ValCLK (under IrohaArria10/@Desktop PC)

- Si5341A-D-GM
- Reference pages
 - ◆ <http://www.picfun.com/f1/f06.html>
 - ◆ <https://sites.google.com/site/de0defpga/verilog-hdl/i2cbasumasuta-i2c-bus-master>
 - ◆ <http://sudoteck.way-nifty.com/blog/2010/06/i2c-read-d57b.html>
- i2c_interface_SI5341A.v and Set_SI5341A_OnePage.v
 - ◆ 2 test versions
 - ◆ This can read/write 0xFF at the register of 0xFF.
- Set_SI5341A
 - ◆ a full version
 - ◆ This can read/write 0xFF at the register of 0xEEFF, where 0xEE is the page of the register. This is controlled by 0x0001.
- I can read the register and it looked OK.
 - ◆ ex) 0x74 can be seen in the register of 0x000B.
 - ◆ I did several checks for read/write. They looked OK.
 - ◆ A WRITE-READ test using 0x0018, 2M clock (the value of this register is 0xFF)
 - ◇ write 0xF0 and then read soon. It was 0xF0.
 - ◇ after a few 10 min (w/o power off), I tried to read it again. It was 0xF0.
 - ◇ then, power off. Then I read it again. It was 0xFF.
- However, I cannot see 100MHz etc clock at the OUT6.
- Clock configuration
 - ◆ Test07-ValCLK/ClockSettingsFiles
 - ◇ CONF1 ... 100MHz (OUT6) etc
 - ◇ CONF2 ... 200MHz (OUT6) etc
- Clock for I2C
 - ◆ 2MHz clock is accepted. (I don't know if this is OK but it looked to work well.)
 - ◇ The value of the clock is for the argument of this module. This is not a real SCL clock.
 - ◇ SCL clock is around one 3rd of the given clock, for example, in case of 2M clock, SCL clock is around 700MHz.
 - ◆ I also tried to use 1.2M clock, which might be close to 400kHz I2C. But I did not test the setting with this clock so much. After that, I have used 1.2MHz as default and several checks were did but I cannot see 100MHz clock like 2MHz.
 - ◆ I also tried to add many mode_i2c to decrease clock less than 100kHz (this is a standard I2C) but I cannot see 100MHz clock.
- Checks with oscilloscope
 - ◆ Pins looked OK.
 - ◆ FINC was set to 0 in Quartus but the situation did not change (100MHz cannot be made...)
 - ◇ I don't need to use this pin (probably I can also do 0x0339 to 0x00.).
 - ◆ A pulse of the 48MHz oscillator is not so good. It could be one of reasons why we cannot make clocks... (this is my guess.)

Test08-Nios (under IrohaArria10/@Desktop PC)

- Section 5 of FPGA Altera Book
 - ◆ <https://service.macnica.co.jp/library/113961>
 - ◆ <https://service.macnica.co.jp/library/114097>
 - ◆ <https://qiita.com/daxanya1/items/917c92ec6c642bd8e9b5>

- ◆ <https://service.macnica.co.jp/support/faq/115129>
- ◆ <http://fpga.seanwrall.com/lessons/lesson2/>
- ◆ A simple NIOS2 program worked: LED is changed according to dis-switch.
 - ◇ First step
 - NIOS2 block was made by using "Platform Designer" (its old name is Qsys).
 - I used NIOS2, PIO for INPUT (dip-switch, 4bits) and OUTPUT (LED, 4bits), On-Chip memory, JTAG uart, Sysid.
 - ◆ Base address -> Use "System -> Assign Base address" tool.
 - ◇ Second step
 - Made a top level program in Quartus. (Test08.v) This is very simple.
 - ◇ Third step
 - Made a NIOS2 program by using "Nios II Software Build Tools for Eclipse". This is also simple.
 - Made a workspace.
 - I used "Hello World Small" as a template but all the initial code was deleted.
 - IORD_ALTERA_AVALON_PIO_DATA(PIO_1_BASE) etc must be used.
 - ◇ Run
 - Load Test08.v program to FPGA by using Programmer at Quartus.
 - "Run" or "Debug" NIOS2 at Eclipse.
- Also I tried to run QuestaSim.
 - ◆ <https://service.macnica.co.jp/library/110605>
 - ◆ <http://www.lab3.kuis.kyoto-u.ac.jp/~ktakagi/le3a/flow/simulation.html>
 - ◆ QuestaSim path
 - ◇ Tools -> Options -> EDA Tool Options -> C:\questasim64_10.7b\win64 for QuestaSim
 - ◆ To make a testbench, use "Assignments -> Settings".
 - ◇ EDA Tool Settings -> Simulation
 - Select "Compile test bench", and select vt file, which must be made with an empty before, for example, testbench08.vt under */simulation/modelsim/
 - Then, Processing -> Start -> Start Test Bench Template Writer
 - Edit the testbench08.vt file.
 - ◇ Run simulation from Quartus
 - Tools -> Run Simulation Tool -> Gate Level Simulation, then QuestaSim window is opened by Quartus.
 - If you see Error (#Error loading design), try to "Recompile" *tst file of "work" in the "Library" window at QuestaSim. Click the right button and select "Recompile".
 - By using QuestaSim, run simulation: Simulate -> Start Simulation. A new windows is opened by QuestaSim. Then select gate_work/*tst (or work/*tst, probably they are the same) and click OK.
 - We can open a "Wave" window from the "View" menu.
 - We can save signal lines used in the Wave window, then we can load it next time.

Test09-GXB(-tryX) (under IrohaArria10/@Desktop PC)

- Info from Nicolas:
 - https://fpgawiki.intel.com/wiki/High_Speed_Transceiver_Demo_Designs_For_Current_and_Older_Families#
 - ◆ I used 4-lanes Arria10 GX PCIe Development Kit from the "Transceiver Toolkit Designs"
 - ◇ Assmerbler: Can't use configuration device EPCQL256 with selected programming mode (in Quatus 18.0)

- See <https://forums.intel.com/s/question/0D50P00003yyTHPSA2/assmerbler-cant-use-conf>
 - remove set_global_assignment -name USE_CONFIGURATION_DEVICE ON from the qsf file.
- I tried to make a similar one with 3 links (P[1], [2], [5] which have a correct polarity).
 - ◆ I used ARRIA_10_RF40_4_20180920_simple.qsf.
 - ◆ Error (14566): The Fitter cannot place 3 periphery component(s) due to conflicts with existing constraints (3 HSSI_PMA_TX_BUF(s)). * I tried to make the same but new project from scratch (-try2) to avoid this error but it was not successful.

Test09-GXB-VHDL

- I did copy and paste from 12-lane's VHDL code from the example used in Test09-GXB. It looked to work well. I need to understand what is different from Verilog.
 - ◆ ARRIA_10_RF40_4_20180920_simple12_VHDLTest.qsf
- Why cannot we see the polarity issue?
 - ◆ Not sure but probably the BER test trasmit data one-lane-by-one-lane.
- Current monitor
 - ◆ By adding one-lane test, around 0.01V increased.
 - ◆ Test1 case
 - ◇ Switch off 0.04A, Switch on 1.03A (3 pairs of microPOD are connected with TX-RX cables.), Fireware load 1.48A, Then 1.52A after doing some tests, 12-lanes BER test 1.62-1.63A, Turn off 12-lanes BER test 1.52A.
 - ◇ Before having 3-pairs, I ran the same Firmware with only 1-pair and I saw large BER in lane 9 or 10 (I don't remember it) but after having 3-pairs, I did not see such relatively large BER in any lane of 12-lanes (I did not use 36-lanes.).
 - I don't know its reason but the physical connection was improved?
 - $2E10^{13}$ or more in all the lanes (12) and I saw 1 BER in the lane 6 (BER= $4.7E10^{-14}$).

Test09-GXB-VHDL-SMA

- ARRIA_10_RF40_4_20180922_SMA_VHDLTest.qsf
- REFCLK_UPOD0_P (PIN_AE7, Bank 4F) cannot be used for SMA, which are in Bank 1H (PIN_E33, PIN_A37).
- REFCLK_UPOD2_P (PIN_N33, Back 1G) can be used by using x6/xN feature (as far as I understood).
 - ◆ xN Clock Line: xN Up/xN Down can access the neighbor banks. MCGB (Master CGB) ports of ATX PLL can be used.
- SMA cable = GX 03272
 - ◆ 6Gbps : BER = 0 with $10E^{12}$
 - ◆ 12.5Gbps: BER = $1.55E^{-2}$
- SMA cable = 135101-R1-M0.50
 - ◆ 12.5Gbps: BER = $1.55E^{-2}$

Test09-GXB-VHDL-MultiPODs

- Try to use 3-pairs of MicroPOD simultaneously.
- First I tried 3-pairs but it did not work: Firmware was compiled and fitted well but the ecorizer(?) cannot be identified.
 - ◆ "FOR i IN 0 to (NUMBER_OF_XCVR_LANE-1) GENERATE" was used to use 3-pairs.
 - ◆ I knew that the 3rd MicroPOD receiver (MircoPOD2) was broken when we tried to fix other issue.

- ◆ I think that we can use its transceiver.
- Second I tried 2-pairs (MicroPOD0 and MicroPOD1) and it worked well.
 - ◆ "FOR i IN 0 to (NUMBER_OF_XCVR_LANE-2) GENERATE" was used to use 2-pairs.
 - ◆ Compile a firmware, and then run "Transceiver Toolkit" from Tools, System Debugging Tools menu of Quartus.
 - ◆ Current: load firmware 2.06A, run 24-lanes test 2.30A --> around 0.01A per lane
 - ◆ BER: $1E^{-13}$ or more in all the lanes (24) at once and I saw 3 non-zero BER lanes: MicroPOD0 lane 2 BER = $9.0E^{-13}$, lane6 BER = $1.7E^{-11}$, MicroPOD1 lane 8 BER = $1.3E^{-8}$
- Jan 2019
 - ◆ I used Si5341 as Clock for MicroPOD.
 - ◇ 125MHz ... A test with the Transceiver Toolkit worked well. ("Locked")
 - ◇ 300MHz ... Not works (not locked)
 - ◇ 126MHz ... BER. It sometimes became non-locked. Unstable.
 - ◇ 156.25MHz ... BER. It sometimes became non-locked. Unstable.
 - Even if I changed ATXPLL's clock to 156.25MHz (from 125MHz), it was unstable. (unlocked sometimes...)

Test10-CLK-I2C

- Used Open Core's I2C program but the situation was not improved.
 - ◆ The observed result is the same as Test07-ValCLK.
- 2019 Jan
 - ◆ I found my mistake, that is, we need preamble and post configurations to change the register's values.
 - ◇ I thought that such configurations are needed only to change the default values. (I realized that some parameter values are different to do it.)
 - ◇ I introduced a 10ms wait time after power on.
 - ◇ I added 300ms wait time as suggested by Clock Builder application.
 - ◆ I checked 9 outputs with oscilloscope. They are OK in term of freq but the shape is not so good (for me) but it should be OK, they are small swing around $V = \sim +0.9V$. This is LVDS.
 - ◇ 300MHz (MOV_0956), 625MHz (MOV_0955), 644.53MHz (MOV_0954) outputs are not good because strange behaviors were observed in a simple LED test program.
 - MOV_0954 and 0955... I expected that LED moves (no-blink LED moves L to R) with about 0.9 sec's step but this was not.
 - MOV_0956 ... LED moved with an opposite direction. I don't understand it.
 - 300MHz, 625MHz, 644.53MHz seems to be small width (?) $\sim 0.9V$ (max), which is difference between P and N.
 - ◇ LOLb was H for both CONF05-2 and CONF06.
 - ◆ LOLb ... Status pin (H is "PLL is locked", that is, good status. L is out-of-lock, that is, bad status.)
 - ◆ FINC ... I don't use it. This is a pin to change freq according to register values.
 - ◆ OUT6 (REFCLK_VAL_P0) is connected to a standard FPGA bank but others (8 OUTs) are connected to GTX banks.
 - ◆ I made Si5341_I2C.vhd to use this clock in other projects.

Test11-NIM

- NIM IN
 - ◆ I connected NIM IN to LED. I inputed 1Hz NIM pulse ($-0.7V$ or $-0.8V$), which was generated by AFG 2105 function generator.
 - ◇ Two NIM input pins worked well. I can see blinking of LED up to 20Hz by my eyes.
 - High freq should be tested by other ways in future.

◇ -0.7V/-0.8V -> Red of LED, 0V -> null on LED

- NIM OUT

- ◆ When I don't do anything but turn on IROHA, two NIM out pins output -0.8V.
 - ◇ When I switch off IROHA, two NIM out pins is 0V.
- ◆ Strange

FPGA N0	0	0	1	1
FPGA P0	0	1	0	1
NIM OUT0	-0.8V	-0.8V	0V	-0.8V

FPGA N1	0	0	1	1
FPGA P1	0	1	0	1
NIM OUT1	-0.8V	0V	-0.8V	-0.8V

- ◆ I used these pins as standard pins not LVDS.

- NIM OUT

- ◆ I specifies pins as LVDS. (LVDS and Diff) as follows:
 - ◇ set_instance_assignment -name IO_STANDARD LVDS -to NIM_DOUTP0
 - ◇ set_instance_assignment -name INPUT_TERMINATION DIFFERENTIAL -to NIM_DOUTP0
- ◆ Still strange (but solved!)
 - ◇ When I don't do anything but turn on IROHA, two NIM out pins output -0.8V.

FPGA P0	1	0
NIM P0	1	0
NIM OUT0	-0.8V	0V

FPGA P1	1	0
NIM P1	0	1
NIM OUT1	0V	-0.8V

- ◆ I found that in the 1st page of our Kairo-zu, NIM_DOUTP1 and NIM_DOUTN1 are swapped!

Test12-NIC

- RJ45 Socket : 0826-1A1T-23-F
 - ◆ The front LED parts (this is just a kind of light guide) are connected to the backend LED parts.
- RJ45_LED1 (GREEN) and RJ45_LED2 (YELLOW)
 - ◆ 1 in the firmware ... LED = ON
 - ◆ 0 in the firmware ... LED = OFF
 - ◆ When we turn IROHA on, both LEDs are on.

Test13-NominalDDR3

- Just to make example EMIF codes for different DDR3 settings.
 - ◆ emif_0_example_design: IP name = DDR3, default parameters with 2GB (128MB x 16), CL7
 - ◇ Questa ... infinite loop (?) in step 3
 - ◆ emif_0_example_design_DDR3_Default: IP name = DDR3 default, default parameters
 - ◇ Questa ... infinite loop (?) in step 3

Test14-NominalDDR3_Ver15

- Use Quartus v15.0

Test15-NIC2

- <https://qiita.com/homelith/items/a80a5e4d45ea9280145a>

Test15-NIC2-ALTDDO_OUT-CycloneV

- To make ALTDDO_OUT by using GPIO for Arria10, I made ALTDDO_OUT with CycloneV and converted it (see [ug_altera_gpio.pdf](#)).

Test16-DDR3

- Try to make a firmware to use DDR3 via NIOS II.
 - ◆ Used Verilog. Pin assignment (fitter) was failed.

Test17-DDR3

- Try to make a firmware to use DDR3 via NIOS II.
 - ◆ Used VHDL. Pin assignment was failed.
- We may need to consider how to constraint circuits? Indeed if I removed PLL, I was able to do the fit by Fitter.
- I used 125MHz as a clock for Clock Source.
 - ◆ I used a timing analyzer to constraint input clocks : 125MHz and 100MHz.
 - ◇ <https://service.macnica.co.jp/library/111585>
- On-chip memory might work in case of a small memory range but when I used a larger range, NIOS II looked to be crashed (no response).
 - ◆ This is because I overwrite NIOS II code, which was loaded to a part of On-chip memory, for example, 0x1000_8000 - 0x1000_9xxxx.
 - ◆ So, when I used memory of 0x1000_a0000 or later, NIOS II did not crashed.
- NIOS II
 - ◆ See the above Test08-Nios. We can find web sites, which explain how to use NIOS II.
 - ◇ Update BSP (after its configuration or Quartus code) : select "BSP Editor..." from "NIOS II" in the menu, which is shown when I click the right bottom of mouse on the name (shown in the Project Explorer) (with _bsp).
 - ◇ Compile my codes : select "Build Project" in the menu, which is shown when I click the right bottom of mouse on the name (shown in the Project Explorer) (without _bsp).
 - ◇ Run NIOS II : select "3 NIOS Hardware" from "Run As" in the menu, which is shown when I click the right bottom of mouse on the name (shown in the Project Explorer) (without _bsp).
 - ◆ We can use memtest_small.c, which can be found in "Test17-DDR3/software/nios_test1/". This might be opened if we open "Test17-DDR3/Nios2-workspace" as workspace, which might be asked when we run Eclipse.
- LATOME's pin of DQ and DM is OK (fitted).
- IROHA's pin of DQ and DM is OK (fitted). [@CERN, March 2019]
 - ◆ 400MHz not 533MHz was used.
 - ◆ Scatter-Gather DMA: mem-to-mem
 - ◇ Nios II workspace: Test17-DDR3/Nios2-workspace3
 - ◇ Nios II code: Test16-DDR3/software/ddr3_test6, try to use sidma3() ... it looked to work well.

- ◆ Nios II's memtest_small.c
 - ◇ Nios II workspace: Test17-DDR3/Nios2-workspace4
 - ◇ Nios II code: Test16-DDR3/software/ddr3_mem-test-small1
 - 256M bytes: 0x1000_0000 - 0x1fff_ffff is OK.
- Nios II
 - ◆ Once I'll make a new application (from normally a template),
 - ◇ run "Nios II -> Generate BSP" from X_bsp.
 - ◇ run "Build Project" from X.
 - ◇ run "Run Configurations...", then make New_configuration by double-clicking "Nios II Hardware".
 - At the "Target COnection" tab, I selected 5 checks: Ignore mismatched system ID, timestamp, Download ELF, Start processor, Rest the selected target system".
 - ◆ If I want to change memory where I put my firmware, edit "Linker Script" tab by using "BSP Editor..." from X_bsp.

Test18-NIC (CERN)

- NIOS II
 - ◆ Error of "Verify failed between address 0x2000000 and 0x200FFFF"
 - ◇ 1) At Platform Designer (Qsys), change "sysid_0" to "sysid"
 - ◇ 2) At Platform Designer, Nios II's debug_reset_request output should be connected to reset of other components except PLL and "Clock source".
 - ◇ 3) At Eclipse, at Run Configuration, check on on "Reset the selected target system" of Target Connection.
 - ◇ 4) Re-connect UBS cable.
 - ◇ 5) Reduce the size of onchip memory.
- <https://forums.intel.com/s/question/0D50P00003yyQTESA2/cyclone-iv-gx-dev-kit-getting-ethernet-to-work?l>
- Clocks
 - ◆ clk (clk_clk) ... 50MHz, tx_clk ... a clock for MAC registers
 - ◆ rx_clk (eth_tse_0_pcs_mac_...) ... 125MHz ... a clock for GMII
 - ◆ ff_tx_clk and ff_rx_clk (eth_tse_0_transmit/receive_...) ... 100MHz ... a clock for Avalon-ST
 - ◇ I used 3 clocks generated from a single PLL. Also I used the same clock for ETH_GTX_CLK (125MHz).
 - ◇ When I used ETH_RX_CLK (it might be 125MHz), my IP cannot be SW_RESET.
- Loopback
 - ◆ Local loopback
 - ◇ <https://forums.intel.com/s/question/0D50P00003yyMbkSAE/tse-with-sgdma-in-loopback>
 - ◇ PROMIS_EN should be 1 to recieve data from transmit in the loopback mode.
- SGDMA (Scatter-Gather DMA)
 - ◆ <https://forums.intel.com/s/question/0D50P00003yyKQCSA2/memorytomemory-sgdma-problem>
 - ◆ <https://forums.intel.com/s/question/0D50P00003yyNKESA2/nios-ii-data-cache-problem>
 - ◆ Use uncached memory. Perform "alt_dcache_flush_all()" in the present NIOS II version.
 - ◇ find and see HAL API Reference in the internet.

GMII

- Gigabit Media Independent Interface for 1000Base-T
 - ◆ MII ... Media Independent Interface, this is for 100Base-TX and 10Base-T
- Image
 - ◆ Network - RJ45 connector - PHY chip - FPGA (MAC) -
 - ◇ "RJ45 connecor - PHY chip" = Layer 1
 - ◇ "FAPG (MAC) -" = Layer 2

I2C - USB board

- HidSmbus Example (Windows application name)
 - ◆ <https://jp.silabs.com/products/development-tools/interface/cp2112ek-evaluation-kit>
 - ◆ Since I use 0x74 as Si5341 Clock I2C slave address, 0xE8 must be used in this software to access I2C line.
 - ◇ 0x74 is a 7 bit code, then we need to add 0 in the lowest bit to make a 8bit code.
 - ◆ J7 ... I connected 1.8V (external 1.8V applied at H1/TB1) to the middle pin of J7.
 - ◆ J8 ... any configuration seems to be OK.
 - ◆ I can read the memory by using I2C when I don't write a firmware to the Si5341.
 - ◇ 0x02 ... 41, 0x03 ... 53, 0x04 ... 00, 0x05 ... 03 etc
 - ◇ 0x0B ... 74 (Slave address with 7 bits)
 - ◇ 0xE2 ... 03 (it means that we still have 2 regions to write registers's values permanently. See section 8 of Si5341-40-RM.pdf.)
 - So far we don't need to change the default register's values.
 - ◆ After I wrote a firmware to the Si5341, 0x00 is returned. It means that we cannot access register by this board once we write a firmware.
 - ◇ Z (Hi impedance) is set for I2C Clock and Data by firmware but we cannot access.
 - ◆ I tried to write register values by using HidSmbus application but I cannot do it. I think that this is a feature of this application.

Configuration (Flash memory)

- AS configuration
 - ◆ AS = Active Serial
 - ◆ Iroha uses AS x 4 mode.
 - ◆ MSEL[2..0]
 - ◇ AS x1 and x4 : Power on reset (POR) delay with Fast ... 010, Standard ... 011 (1.8V), Note LATOME uses 011.
 - ◆ CLKUSR (AM24 pin) = 100MHz (already set)
- Serial Flash Loader Intel FPGA IP core
 - ◆ AN370 2017.12.18 version
- <https://forums.intel.com/s/question/0D50P00003yyRG2SAM/how-to-use-serial-flash-loader-in-quartus-ii-if-al>
 - ◆ Concerning item 7, I used 10AX115R3.
 - ◆ Concerning item 12 and 13 in this page (intel page), I found two FPGA (one is 10AX115R3F40 and the other is 10AX115R3). I deleted the former one, and then I checked v in the Program/Configure for both FPGA and EPCQL1024.
- Iroha has MT25QU01GBBB8E12-0SIT, which is MT25Q is a high-performance multiple input/output, 1Gb, 1.8V, SPI Flash memory device: EPCQL1024.
- How to erase an image from the flash memory
 - ◆ <https://service.macnica.co.jp/support/faq/91937>
 - ◆ I deleted FPGA which is shown first when I ran the programmer. Then, I added FPGA (10AX115R3) and added Flash (EPCQL1024). Then select "Erase" and click "Start".

Signal tap II

- How to keep or preserve registers to monitor by the Signal tap II.
 - ◆ <http://forum.macnica.co.jp/t/topic/1144>
 - ◇ VHDL ... use attribute dont_merge or preserve
 - ◇ Verilog ... synthesis dont_merge etc.
 - ◇ BUT it did not work well...

This topic: Main > FPGAMemo

Topic revision: r78 - 2019-03-12 - JunichiTanaka



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